

PNP General Purpose Transistor

NST3906F3T5G

The NST3906F3T5G device is a spin-off of our popular SOT-23/SOT-323/SOT-563/SOT-963 three-leaded device. It is designed for general purpose amplifier applications and is housed in the SOT-1123 surface mount package. This device is ideal for low-power surface mount applications where board space is at a premium.

Features

- h_{FE}, 100-300
- Low $V_{CE(sat)}$, $\leq 0.4 \text{ V}$
- Reduces Board Space
- This is a Pb-Free Device

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector - Emitter Voltage	V_{CEO}	-40	Vdc
Collector - Base Voltage	V_{CBO}	-40	Vdc
Emitter – Base Voltage	V_{EBO}	-5.0	Vdc
Collector Current - Continuous	I _C	-200	mAdc

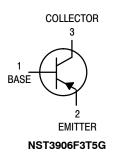
THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation, T _A = 25°C Derate above 25°C	P _D (Note 1)	290 2.3	mW mW/°C
Thermal Resistance, Junction-to-Ambient	R _{θJA} (Note 1)	432	°C/W
Total Device Dissipation, T _A = 25°C Derate above 25°C	P _D (Note 2)	347 2.8	mW mW/°C
Thermal Resistance, Junction-to-Ambient	R _{θJA} (Note 2)	360	°C/W
Thermal Resistance, Junction-to-Lead 3	R _{ΨJL} (Note 2)	143	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	–55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1

- 1. 100 mm² 1 oz, copper traces.
- 2. 500 mm² 1 oz, copper traces.





SOT-1123 CASE 524AA STYLE 1

MARKING DIAGRAM



3 = Device CodeM = Date Code

ORDERING INFORMATION

Device	Package	Shipping [†]
NST3906F3T5G	SOT-1123 (Pb-Free)	8000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

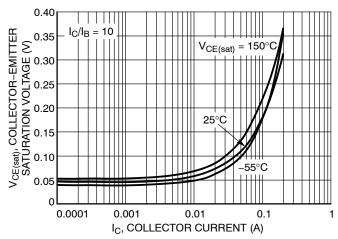
NST3906F3T5G

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

	Characteristic	Symbol	Min	Max	Unit	
OFF CHARACTE	RISTICS	•	•		•	
Collector – Emitter Breakdown Voltage (Note 3) (I _C = 1.0 mAdc, I _B = 0)		V _{(BR)CEO}	-40	_	Vdc	
Collector - Base Br	eakdown Voltage (I _C = 10 μAdc, I _E = 0)	V _{(BR)CBO}	-40	-	Vdc	
Emitter - Base Brea	akdown Voltage (I _E = 10 μAdc, I _C = 0)	V _{(BR)EBO}	-5.0	-	Vdc	
Collector Cutoff Cu	I _{CEX}	-	-50	nAdc		
ON CHARACTER	RISTICS (Note 3)					
$(I_C = -1.0 \text{ mAdc}, I_C = -10 \text{ mAdc}, I_C = -50 \text{ mAdc},$	$V_{CE} = -1.0 \text{ Vdc}$ $V_{CE} = -1.0 \text{ Vdc}$ $V_{CE} = -1.0 \text{ Vdc}$ $V_{CE} = -1.0 \text{ Vdc}$ $V_{CE} = -1.0 \text{ Vdc}$	h _{FE}	60 80 100 60 30	- 300 - -	-	
Collector – Emitter Saturation Voltage ($I_C = -10$ mAdc, $I_B = -1.0$ mAdc) ($I_C = -50$ mAdc, $I_B = -5.0$ mAdc)		V _{CE(sat)}	- -	-0.25 -0.4	Vdc	
Base – Emitter Saturation Voltage ($I_C = -10$ mAdc, $I_B = -1.0$ mAdc) ($I_C = -50$ mAdc, $I_B = -5.0$ mAdc)		V _{BE(sat)}	-0.65 -	-0.85 -0.95	Vdc	
SMALL-SIGNAL	CHARACTERISTICS	l .			· ·	
Current - Gain - Ba	andwidth Product (I _C = 10 mAdc, V _{CE} = 20 Vdc, f = 100 MHz)	f _T	250	-	MHz	
Output Capacitance (V _{CB} = -5.0 V, I _E = 0 mA, f = 1.0 MHz)		C _{obo}	-	4.5	pF	
Input Capacitance (V _{EB} = -0.5 V, I _E = 0 mA, f = 1.0 MHz)		C _{ibo}	-	10.0	pF	
Noise Figure ($V_{CE} = -5.0 \text{ Vdc}$, $I_{C} = -100 \mu \text{Adc}$, $R_{S} = 1.0 \text{ k}\Omega$, $f = 1.0 \text{ kHz}$)		NF	-	4.0	dB	
SWITCHING CHA	ARACTERISTICS	ı	ı			
Delay Time	$(V_{CC} = -3.0 \text{ Vdc}, V_{BE} = 0.5 \text{ Vdc})$	t _d	_	35	ns	
Rise Time	(I _C = -10 mAdc, I _{B1} = -1.0 mAdc)	t _r	-	35		
Storage Time	$(V_{CC} = -3.0 \text{ Vdc}, I_{C} = -10 \text{ mAdc})$	t _s	_	250		

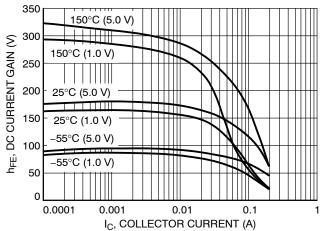
^{3.} Pulse Test: Pulse Width \leq 300 $\mu s;$ Duty Cycle \leq 2.0%.

Fall Time



 $(I_{B1} = I_{B2} = -1.0 \text{ mAdc})$

Figure 1. Collector Emitter Saturation Voltage vs.
Collector Current



ns

50

Figure 2. DC Current Gain vs. Collector Current

NST3906F3T5G

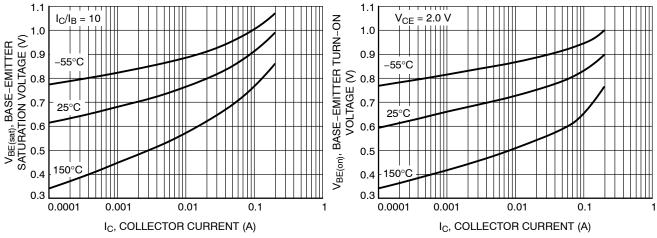


Figure 3. Base Emitter Saturation Voltage vs. Collector Current

Figure 4. Base Emitter Turn-On Voltage vs.
Collector Current

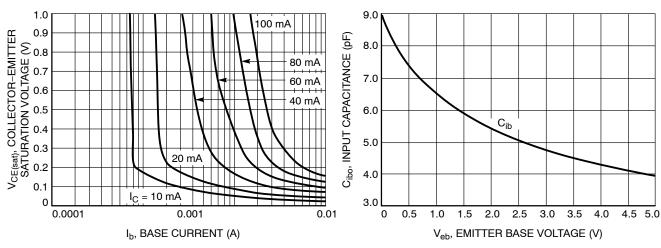


Figure 5. Saturation Region

Figure 6. Input Capacitance

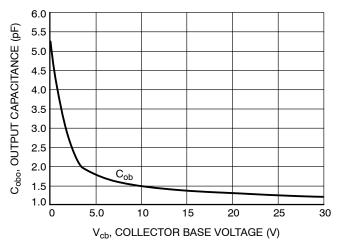


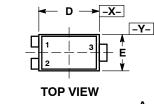
Figure 7. Output Capacitance

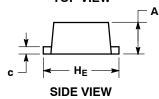


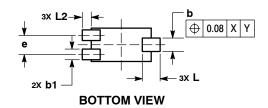
SOT-1123 CASE 524AA ISSUE C

DATE 29 NOV 2011

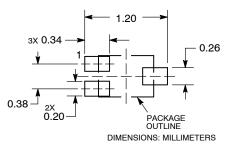
SCALE 8:1







SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

NOTES:

- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

 2. CONTROLLING DIMENSION: MILLIMETERS.
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE
- MINIMUM THICKNESS OF BASE MATERIAL.
 DIMENSIONS D AND E DO NOT INCLUDE MOLD
 FLASH, PROTRUSIONS, OR GATE BURRS.

	MILLIMETERS			
DIM	MIN	MAX		
Α	0.34	0.40		
b	0.15	0.28		
b1	0.10	0.20		
С	0.07	0.17		
D	0.75	0.85		
E	0.55	0.65		
е	0.35	0.40		
HE	0.95	1.05		
L	0.185 REF			
L2	0.05 0.15			

GENERIC MARKING DIAGRAM*



= Specific Device Code Χ Μ = Date Code

*This information is generic. Please refer to device data sheet for actual part

marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

STYLE 1:	STYLE 2:	STYLE 3:	STYLE 4:	STYLE 5:
PIN 1. BASE	PIN 1. ANODE	PIN 1. ANODE	PIN 1. CATHODE	PIN 1. GATE
2. EMITTER	2. N/C	2. ANODE	2. CATHODE	2. SOURC
3. COLLECTOR	3. CATHODE	3. CATHODE	3. ANODE	3. DRAIN

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DESCRIPTION:	SOT-1123, 3-LEAD, 1.0X0.6X0.37, 0.35P		PAGE 1 OF 1	

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